# **Surface Mount General Purpose Rectifier**





## Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High forward surge capability
- $\bullet$  Meets MSL level 1, per J-STD-020, LF maximum peak of 260  $^\circ\text{C}$
- Part no. with suffix "Q" means AEC-Q101 qualified

## **Typical Applications**

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive and telecommunication.

#### **Mechanical Date**

- Package: SOD-123FL Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end

## **■Maximum Ratings** ( $T_a$ =25 °C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	G1AQ	G1BQ	G1DQ	G1GQ	G1JQ	G1KQ	G1MQ
Device marking code			G1A	G1B	G1D	G1G	G1J	G1K	G1M
Repetitive peak reverse voltage	V <sub>RRM</sub>	V	50	100	200	400	600	800	1000
Maximum RMS voltage	V <sub>RMS</sub>	V	35	70	140	280	420	560	700
Maximum average forward rectified current at $T_{L}\left(Fig.1\right)$	I <sub>F(AV)</sub>	А	1.0						
Surge(non-repetitive)forward current @ 60Hz half-sine wave,1 cycle, $T_J$ =25°C	I <sub>FSM</sub>	А	30						
Current Squared Time @1ms≤t<8.3ms Tյ=25℃	l <sup>2</sup> t	A <sup>2</sup> s	3.7						
Storage temperature	T <sub>STG</sub>	°C	-55 ~+175 -55 ~+1				+150		
Junction temperature	TJ	°C	-55 ~+175 -55 ~+1			+150			
Power dissipation	Pd	w	1.42 1.19			19			

# ■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	G1AQ	G1BQ	G1DQ	G1GQ	G1JQ	G1KQ	G1MQ
Maximum instantaneous forward voltage drop per diode	V <sub>F</sub>	V	I <sub>FM</sub> =1.0A	1.1						
Typical junction capacitance	CJ	pF	V <sub>R</sub> =4V,1 MHz	10						
Maximum DC reverse current at			Ta=25℃ 5							
rated DC blocking voltage per diode	I <sub>RRM</sub>	μA	Ta=125℃	50						



# G1AQ THRU G1MQ

## ■Thermal Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	ТҮР	МАХ
	R <sub>0J-A</sub>		85 <sup>1)</sup>	105 <sup>1)</sup>
Thermal Resistance	R <sub>θJ-L</sub>	°C/W	35 <sup>1)</sup>	45 <sup>1)</sup>
	R <sub>θJ-SP</sub>		17 <sup>2)</sup>	20 <sup>2)</sup>

Note:

(1) Thermal resistance between junction and ambient and between junction and lead mounted on P.C.B with 3mm\*3mm copper pad areas.

(2) Thermal resistance between junction and cathode tab solder point.

#### Characteristics(Typical)



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# Outline Dimensions



SOD-123FL						
Dim	Min	Max				
А	1.60	1.90				
В	0.90	1.10				
С	2.55	2.85				
D	3.60	3.90				
Е	1.00	1.20				
F	0.40	0.90				
G	0.10	0.25				
Н	0.02	0.05				

# Suggested pad layout



SOD-123FL					
Dim Millimeters					
P1	3.90				
P2	1.90				
Q1	1.00				
Q2	1.50				





# Marking Information





# ■Packing Information

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
G1AQ ~ G1MQ	F1	0.0169	3000	30000	120000	7" reel



# **G1AQ THRU G1MQ**

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